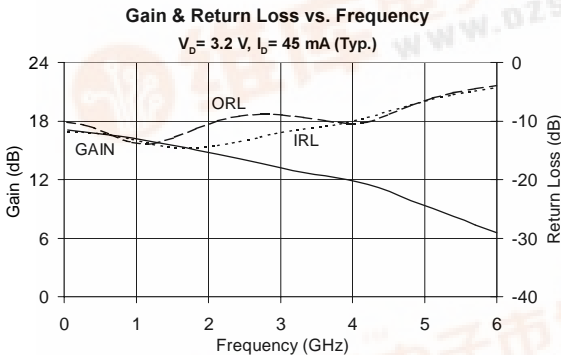


## Product Description

Stanford Microdevices' SGA-4363 is a high performance SiGe Heterojunction Bipolar Transistor MMIC Amplifier. A Darlington configuration featuring 1 micron emitters provides high  $F_T$  and excellent thermal performance. The heterojunction increases breakdown voltage and minimizes leakage current between junctions. Cancellation of emitter junction non-linearities results in higher suppression of intermodulation products. At 850 MHz and 45mA, the SGA-4363 typically provides +28.7 dBm output IP3, 16.4 dB of gain, and +14.3 dBm of 1dB compressed power using a single positive voltage supply. Only 2 DC-blocking capacitors, a bias resistor and an optional RF choke are required for operation.



## SGA-4363

### DC-2000 MHz, Cascadable SiGe HBT MMIC Amplifier



### Product Features

- High Gain : 14.8 dB at 1950 MHz
- Cascadable 50 Ohm
- Patented SiGe Technology
- Operates From Single Supply
- Low Thermal Resistance Package

### Applications

- Cellular, PCS, CDPD
- Wireless Data, SONET
- Satellite

Symbol	Parameter	Units	Frequency	Min.	Typ.	Max.
G	Small Signal Gain	dB	850 MHz	14.8	16.4	18.0
$P_{1dB}$	Output Power at 1dB Compression	dBm	850 MHz		14.3	
$OIP_3$	Output Third Order Intercept Point (Power out per tone = -5dBm)	dBm	850 MHz		28.7	
Bandwidth	Determined by Return Loss (<-10dB)	MHz			2000	
IRL	Input Return Loss	dB	1950 MHz		14.4	
ORL	Output Return Loss	dB	1950 MHz		10.7	
NF	Noise Figure	dB	1950 MHz		3.1	
$V_D$	Device Voltage	V		2.9	3.2	3.5
$R_{Th}$	Thermal Resistance	°C/W			255	

#### Test Conditions:

$V_S = 8\text{ V}$

$I_D = 45\text{ mA Typ.}$

$OIP_3$  Tone Spacing = 1 MHz, Pout per tone = -5 dBm

$R_{BIAS} = 110\text{ Ohms}$

$T_L = 25^\circ\text{C}$

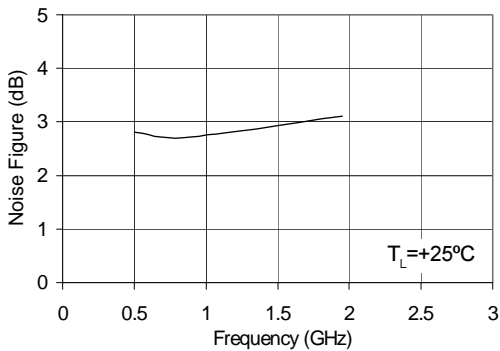
$Z_S = Z_L = 50\text{ Ohms}$

**Typical RF Performance at Key Operating Frequencies**

Symbol	Parameter	Unit	Frequency (MHz)					
			100	500	850	1950	2400	3500
G	Small Signal Gain	dB	17.0	16.7	16.4	14.8		
OIP <sub>3</sub>	Output Third Order Intercept Point	dBm		29.4	28.7	25.7		
P <sub>1dB</sub>	Output Power at 1dB Compression	dBm		14.3	14.3	13.0		
IRL	Input Return Loss	dB	11.9	12.2	12.9	14.4		
ORL	Output Return Loss	dB	10.2	11.5	13.3	10.7		
S <sub>12</sub>	Reverse Isolation	dB	20.9	21.4	21.4	20.7		
NF	Noise Figure	dB		2.8	2.7	3.1		

**Test Conditions:** V<sub>S</sub> = 8 V, I<sub>D</sub> = 45 mA Typ., OIP<sub>3</sub> Tone Spacing = 1 MHz, P<sub>out</sub> per tone = -5 dBm  
R<sub>BIAS</sub> = 110 Ohms, T<sub>L</sub> = 25°C, Z<sub>S</sub> = Z<sub>L</sub> = 50 Ohms

**Noise Figure vs. Frequency**  
V<sub>D</sub> = 3.2 V, I<sub>D</sub> = 45 mA (Typ.)



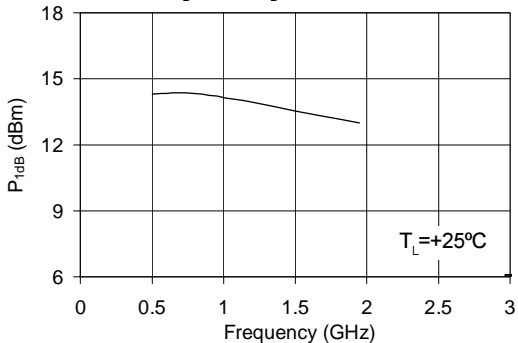
**Absolute Maximum Ratings**

Parameter	Absolute Limit
Max. Device Current (I <sub>D</sub> )	90 mA
Max. Device Voltage (V <sub>D</sub> )	5 V
Max. RF Input Power	+8 dBm
Max. Junction Temp. (T <sub>J</sub> )	+150°C
Operating Temp. Range (T <sub>L</sub> )	-40°C to +85°C
Max. Storage Temp.	+150°C

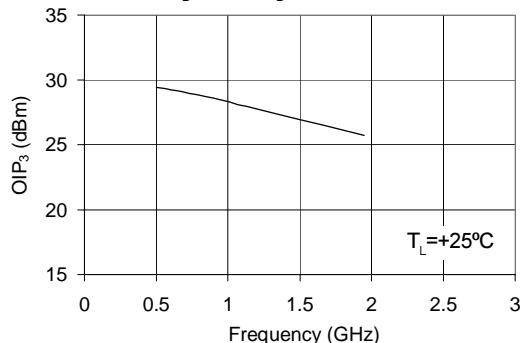
Operation of this device beyond any one of these limits may cause permanent damage.

Bias Conditions should also satisfy the following expression: I<sub>D</sub>V<sub>D</sub> (max) < (T<sub>J</sub> - T<sub>L</sub>)/R<sub>th</sub>

**OIP<sub>3</sub> vs. Frequency**  
V<sub>D</sub> = 3.2 V, I<sub>D</sub> = 45 mA (Typ.)

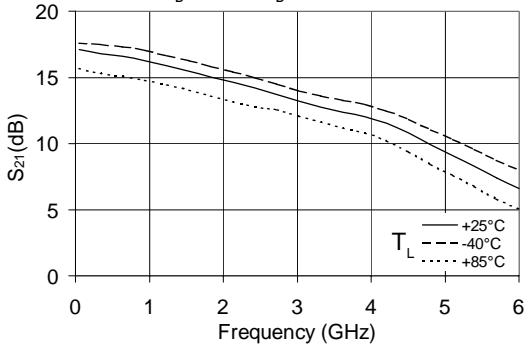


**P<sub>1dB</sub> vs. Frequency**  
V<sub>D</sub> = 3.2 V, I<sub>D</sub> = 45 mA (Typ.)



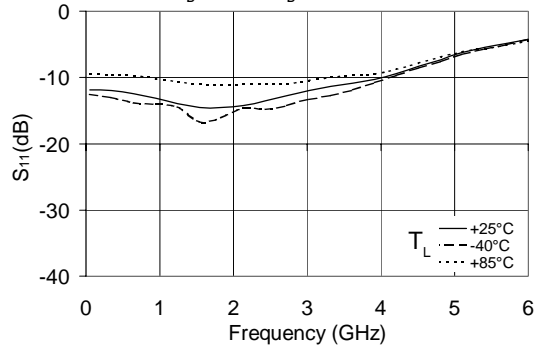
**$|S_{21}|$  vs. Frequency**

$V_D = 3.2$  V,  $I_D = 45$  mA (Typ.)



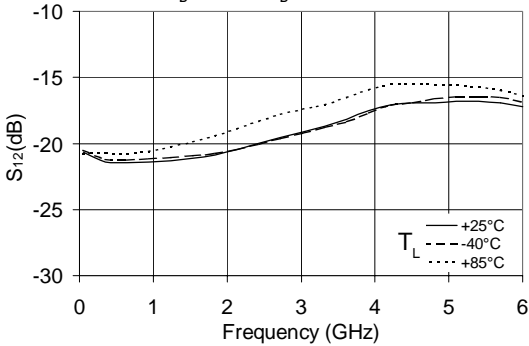
**$|S_{11}|$  vs. Frequency**

$V_D = 3.2$  V,  $I_D = 45$  mA (Typ.)



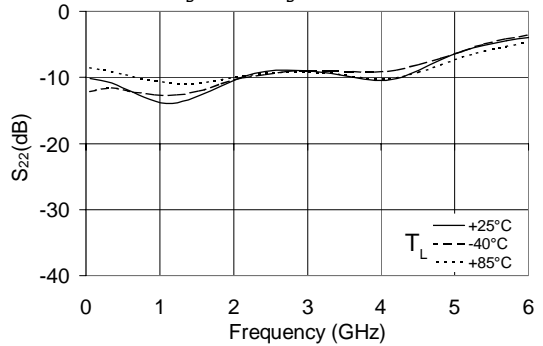
**$|S_{12}|$  vs. Frequency**

$V_D = 3.2$  V,  $I_D = 45$  mA (Typ.)



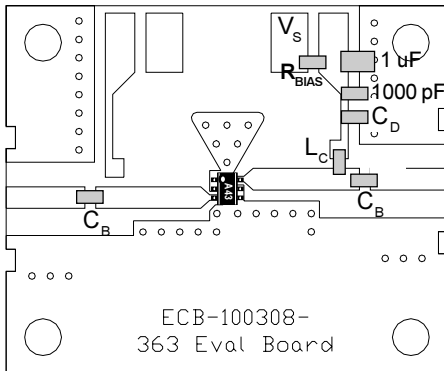
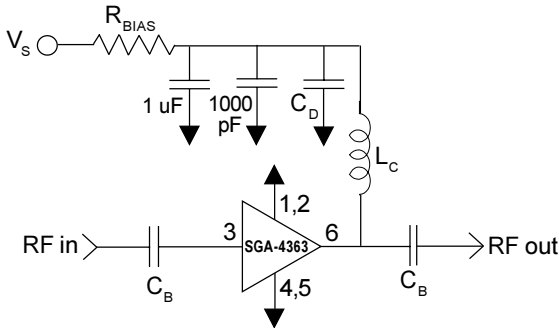
**$|S_{22}|$  vs. Frequency**

$V_D = 3.2$  V,  $I_D = 45$  mA (Typ.)



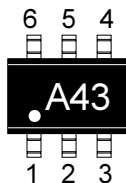
NOTE: Full S-parameter data available at [www.stanfordmicro.com](http://www.stanfordmicro.com)

### Basic Application Circuit



#### Part Identification Marking

The part will be marked with an "A43" designator on the top surface of the package.



For package dimensions, refer to outline drawing at [www.stanfordmicro.com](http://www.stanfordmicro.com)

#### Application Circuit Element Values

Reference Designator	Frequency (Mhz)				
	500	850	1950	2400	3500
$C_B$	220 pF	100 pF	68 pF	56 pF	39 pF
$C_D$	100 pF	68 pF	22 pF	22 pF	15 pF
$L_C$	68 nH	33 nH	22 nH	18 nH	15 nH

#### Recommended Bias Resistor Values for $I_b=45mA$

Supply Voltage( $V_S$ )	6 V	8 V	10 V	12 V
$R_{BIAS}$	62 $\Omega$	110 $\Omega$	150 $\Omega$	200 $\Omega$

Note:  $R_{BIAS}$  provides DC bias stability over temperature.

#### Mounting Instructions

1. Use a large ground pad area near device pins 1, 2, 4, and 5 with many plated through-holes as shown.
2. We recommend 1 or 2 ounce copper. Measurements for this data sheet were made on a 31 mil thick FR-4 board with 1 ounce copper on both sides.

Pin #	Function	Description
3	RF IN	RF input pin. This pin requires the use of an external DC blocking capacitor chosen for the frequency of operation.
1	GND	Connection to ground. Use via holes for best performance to reduce lead inductance as close to ground leads as possible.
6	RF OUT/BIAS	RF output and bias pin. DC voltage is present on this pin, therefore a DC blocking capacitor is necessary for proper operation.
2,4,5	GND	Sames as Pin 2

#### Part Number Ordering Information

Part Number	Reel Size	Devices/Reel
SGA-4363	7"	3000



#### Caution: ESD sensitive

Appropriate precautions in handling, packaging and testing devices must be observed.